CMOS Digital Integrated Circuits Silicon Monolithic

74VHC74FT

1. Functional Description

Dual D-Type Flip-Flop with Preset and Clear

2. General

The 74VHC74FT is an advanced high speed CMOS D-FLIP FLOP fabricated with silicon gate C2MOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The signal level applied to the D INPUT is transferred to Q OUTPUT during the positive going transition of the CK pulse.

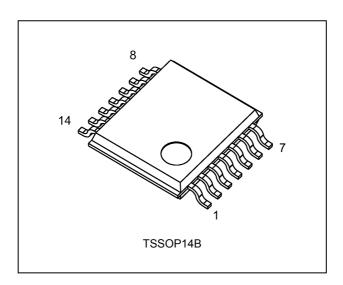
 $\overline{\text{CLR}}$ and $\overline{\text{PR}}$ are independent of the CK and are accomplished by setting the appropriate input low.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

3. Features

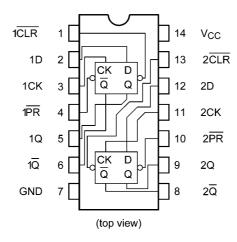
- (1) High speed: $f_{MAX} = 170 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- (2) Low power dissipation: $I_{CC} = 2 \mu A \text{ (max)}$ at $T_a = 25 \text{°C}$
- (3) High noise immunity: $V_{NIH} = V_{NIL} = 28\% V_{CC}$ (min)
- (4) Power-down protection is provided on all inputs.
- (5) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (6) Wide operating voltage range: $V_{CC(opr)} = 2 \text{ V to } 5.5 \text{ V}$
- (7) Pin and function compatible with the 74 series (74AC/HC/AHC etc.) 74 type.

4. Packaging

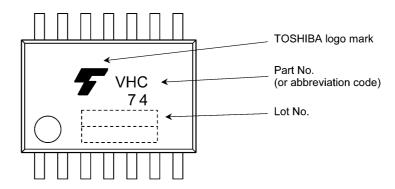




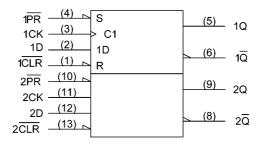
5. Pin Assignment



6. Marking



7. IEC Logic Symbol



8. Truth Table

Inputs				Out	puts	Function	
CLR	PR	D	СК	Q	Q	FullClion	
L	Н	Х	Х	L	Ι	Clear	
Н	L	Х	Х	Н	L	Preset	
L	L	Х	Х	Н	Η	1	
Н	Н	L		L	Н		
Н	Н	Н		Н	L	1	
Н	Н	Х	\Box	Qn	\overline{Q}_n	No Change	

X: Don't care

Rev.1.0



9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	-0.5 to 7.0	V
Input voltage	V _{IN}	-0.5 to 7.0	V
Output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	-20	mA
Output diode current	I _{OK}	±20	mA
Output current	I _{OUT}	±25	mA
V _{CC} /ground current	I _{CC}	±50	mA
Power dissipation	P_D	180	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

10. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V _{CC}		2.0 to 5.5	V
Input voltage	V _{IN}		0 to 5.5	V
Output voltage	V _{OUT}		0 to V _{CC}	V
Operating temperature	T _{opr}		-40 to 85	°C
Input rise and fall times	dt/dv	V_{CC} = 3.3 ± 0.3 V	0 to 100	ns/V
		V _{CC} = 5 ± 0.5 V	0 to 20	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs and bus inputs must be tied to either V_{CC} or GND.



11. Electrical Characteristics

11.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Condition		V _{CC} (V)	Min	Тур.	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	_	V
				3.0 to 5.5	$V_{CC} \times 0.7$	_	_	
Low-level input voltage	V _{IL}	_		2.0	_	_	0.50	V
				3.0 to 5.5	_	_	$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	2.0	_	V
				3.0	2.9	3.0	_	
				4.5	4.4	4.5	_	
			I_{OH} = -4 mA	3.0	2.58	_	_	
			I _{OH} = -8 mA	4.5	3.94		_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.0	0.1	V
				3.0	_	0.0	0.1	
				4.5	_	0.0	0.1	
			I _{OL} = 4 mA	3.0	_	_	0.36	
			I _{OL} = 8 mA	4.5	_	_	0.36	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5		_	±0.1	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		5.5	_	_	2.0	

11.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

Characteristics	Symbol	Test Condition	1	V _{CC} (V)	Min	Max	Unit
High-level input voltage	V _{IH}	_		2.0	1.50	_	V
				3.0 to 5.5	V _{CC} × 0.7	_	
Low-level input voltage	V _{IL}	_		2.0	_	0.50	V
				3.0 to 5.5		$V_{CC} \times 0.3$	
High-level output voltage	V _{OH}	$V_{IN} = V_{IH}$ or V_{IL}	I _{OH} = -50 μA	2.0	1.9	_	V
				3.0	2.9	_	
				4.5	4.4	_	
			$I_{OH} = -4 \text{ mA}$	3.0	2.48	_	
			I _{OH} = -8 mA	4.5	3.80	_	
Low-level output voltage	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	_	0.1	V
				3.0	_	0.1	
				4.5	_	0.1	
			I _{OL} = 4 mA	3.0	_	0.44	
			I _{OL} = 8 mA	4.5	_	0.44	
Input leakage current	I _{IN}	V _{IN} = 5.5 V or GND		0 to 5.5		±1.0	μА
Quiescent supply current	I _{CC}	$V_{IN} = V_{CC}$ or GND		5.5	_	20.0	



11.3. Timing Requirements (Unless otherwise specified, T_a = 25°C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	_	3.3 ± 0.3	6.0	ns
(CK)			5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}	_	3.3 ± 0.3	6.0	ns
(CLR,PR)			5.0 ± 0.5	5.0	
Minimum setup time	t _S	_	3.3 ± 0.3	6.0	ns
			5.0 ± 0.5	5.0	
Minimum hold time	t _h	_	3.3 ± 0.3	0.5	ns
			5.0 ± 0.5	0.5	
Minimum removal time	t _{rem}	_	3.3 ± 0.3	5.0	ns
(CLR,PR)			5.0 ± 0.5	3.0	

11.4. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 85°C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Limit	Unit
Minimum pulse width	$t_{w(L)},t_{w(H)}$	_	3.3 ± 0.3	7.0	ns
(CK)			5.0 ± 0.5	5.0	
Minimum pulse width	t _{w(L)}		3.3 ± 0.3	7.0	ns
(CLR,PR)			5.0 ± 0.5	5.0	
Minimum setup time	t _S	_	3.3 ± 0.3	7.0	ns
			5.0 ± 0.5	5.0	
Minimum hold time	t _h	_	3.3 ± 0.3	0.5	ns
			5.0 ± 0.5	0.5	
Minimum removal time	t _{rem}	—	3.3 ± 0.3	5.0	ns
(CLR,PR)			5.0 ± 0.5	3.0	

11.5. AC Characteristics (Unless otherwise specified, T_a = 25 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Note	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Unit
Propagation delay time	t_{PLH}, t_{PHL}		_	3.3 ± 0.3	15	_	6.7	11.9	ns
(CK-Q,Q)					50	_	9.2	15.4	
				5.0 ± 0.5	15	_	4.6	7.3	
					50	_	6.1	9.3	
Propagation delay time	t_{PLH}, t_{PHL}		_	3.3 ± 0.3	15	_	7.6	12.3	ns
$(\overline{CLR},\overline{PR},-Q,\overline{Q})$					50	_	10.1	15.8	
				5.0 ± 0.5	15	_	4.8	7.7	
					50		6.3	9.7	
Maximum clock frequency	f _{MAX}		_	3.3 ± 0.3	15	80	125		MHz
					50	50	75		
				5.0 ± 0.5	15	130	170		
					50	90	115		
Input capacitance	C _{IN}		_		·	_	4	10	pF
Power dissipation capacitance	C_{PD}	(Note 1)	_		·	_	25		pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation.

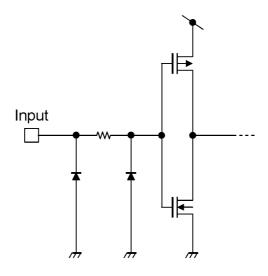
 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/2 \text{ (per F/F)}$



11.6. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 3 ns)

Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Max	Unit
Propagation delay time	t _{PLH} ,t _{PHL}	_	3.3 ± 0.3	15	1.0	14.0	ns
(CK-Q,Q)				50	1.0	17.5	
			5.0 ± 0.5	15	1.0	8.5	
				50	1.0	10.5	
Propagation delay time	t _{PLH} ,t _{PHL}	_	3.3 ± 0.3	15	1.0	14.5	ns
$(\overline{CLR},\overline{PR}-Q,\overline{Q})$				50	1.0	18.0	
			5.0 ± 0.5	15	1.0	9.0	
				50	1.0	11.0	
Maximum clock frequency	f _{MAX}	_	3.3 ± 0.3	15	70	_	MHz
				50	45	_	
			5.0 ± 0.5	15	110	_	MHz
				50	75	_	
Input capacitance	C _{IN}	_			_	10	pF

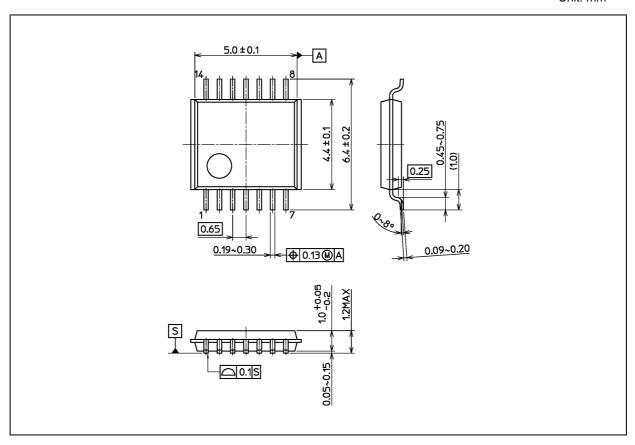
12. Input Equivalent Circuit





Package Dimensions

Unit: mm



Weight: 0.054 g (typ.)

Package Name(s)
Nickname: TSSOP14B



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